

FOR IMMEDIATE RELEASE

TRI brings Inspection Technology Seminar to Penang, Malaysia

[May 3, 2016 – Taipei, Taiwan] Test Research, Inc. (TRI) will host a technology seminar in Malaysia on **May 19, 2016** at Eastin Hotel in Penang. Aimed at production managers and engineers, the one day event will introduce recent technological innovations in the industry's only comprehensive PCBA testing and inspection solution portfolio and highlight the value TRI's award winning systems can provide to manufacturers in an Industry 4.0 based Smart Factory environment.

The seminar agenda will focus on new stop-and-go developments in 3D solder paste inspection (SPI) and 3D automated optical inspection (AOI) with emphasis on accurate 0250125mm micro-chip inspection. including a session on TRI's 3D AXI solutions with CT capability. Board test solutions will be represented by TRI's brand new TR5001D SII INLINE ICT system as well as award winning TINY ICT solution in parallel testing configuration. All introduced systems will be available for on-site product demonstrations.

For more information about the free event, please visit TRI website <http://www.tri.com.tw> or contact Mr. Larry Chen at Larry_Chen@tri.com.tw.

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About TRI

TRI offers the most robust product portfolio in the industry for Automatic Test and Inspection solutions. From Solder Paste Inspection (SPI), Automated Optical Inspection (AOI), and 3D Automated X-ray Inspection (AXI) systems to Manufacturing Defect Analyzers (MDAs) and In-Circuit Test equipment, TRI provides the most cost-effective solutions to meet a comprehensive range of manufacturing Test and Inspection requirements. Learn more at <http://www.tri.com.tw>. For sales and service information, write us at marketing@tri.com.tw or call +886-2-2832 8918.